

1.5A, 200V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.016g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	1.5	Α	
V_{RRM}	200 - 1000	V	
I _{FSM}	40	Α	
T_{JMAX}	150	°C	
Package	SOD-123W		
Configuration	Single die		







SOD-123W



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	HS15D LWH	HS15G LWH	HS15J LWH	HS15K LWH	HS15M LWH	UNIT
Marking code on the device		HS15D	HS15G	HS15J	HS15K	HS15M	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current	I _F			1.5			Α
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	40		А			
Junction temperature	T _J	- 55 to +150			°C		
Storage temperature	T _{STG}	- 55 to +150			°C		



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	43	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	84	°C/W
Junction-to-case thermal resistance	R _{eJC}	45	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
		$I_F = 0.75A, T_J = 25^{\circ}C$		0.82	0.89	V
		I _F = 1.50A, T _J = 25°C		0.88	0.95	V
	HS15DLWH	I _F = 0.75A, T _J = 125°C		0.68	0.75	V
		I _F = 1.50A, T _J = 125°C		0.75	0.80	V
		$I_F = 0.75A, T_J = 25^{\circ}C$		0.86	1.03	V
- (1)		I _F = 1.50A, T _J = 25°C] , [0.93	1.30	V
Forward voltage ⁽¹⁾	HS15GLWH	I _F = 0.75A, T _J = 125°C	V_{F}	0.70	0.85	V
		I _F = 1.50A, T _J = 125°C		0.79	1.05	V
		$I_F = 0.75A, T_J = 25^{\circ}C$		1.17	1.40	V
	HS15JLWH	I _F = 1.50A, T _J = 25°C		1.31	1.70	V
	HS15KLWH HS15MLWH	I _F = 0.75A, T _J = 125°C		0.94	1.12	V
	HSTSWILWH	I _F = 1.50A, T _J = 125°C		1.09	1.30	V
(2)		T _J = 25°C		-	1	μA
Reverse current @ rated '	V _R ⁽⁻⁾	T _J = 125°C	l _R	-	150	μA
	HS15DLWH		C _J 25 22 9	25	-	pF
	HS15GLWH			22	-	pF
Junction capacitance	HS15JLWH	1MHz, $V_R = 4.0V$				
	HS15KLWH			9	-	pF
	HS15MLWH					
Reverse recovery time	HS15DLWH		t _{rr}	_	50	ne
	HS15GLWH	$I_F = 0.5A$, $I_R = 1.0A$ $I_{rr} = 0.25A$			30	ns
	HS15JLWH					
	HS15KLWH	I _{II} = 0.23A		-	75	ns
	HS15MLWH					

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
HS15xLWH	SOD-123W	10,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 200V(HS15DLWH) to 1000V(HS15MLWH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

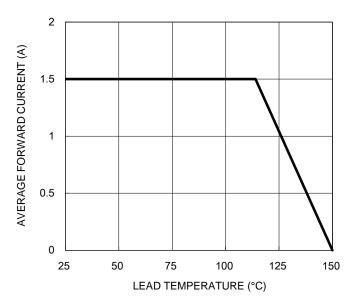


Fig.2 Typical Junction Capacitance

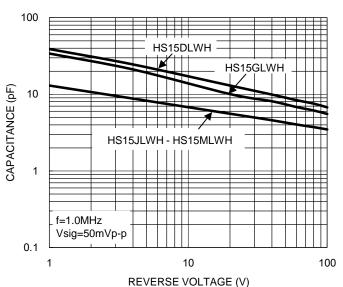


Fig.3 Typical Reverse Characteristics

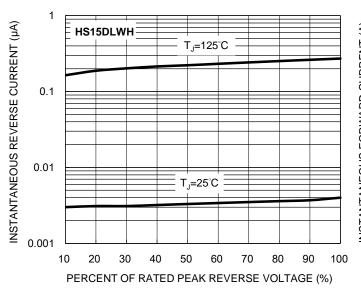
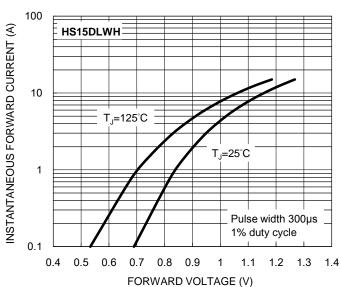


Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.5 Typical Reverse Characteristics

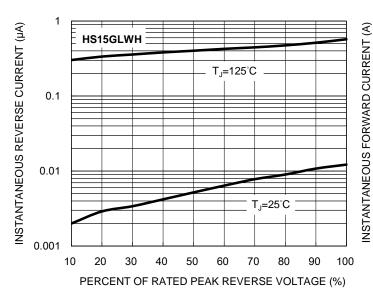


Fig.6 Typical Forward Characteristics

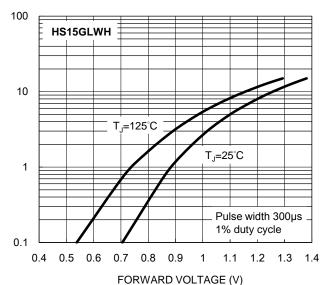


Fig.7 Typical Reverse Characteristics

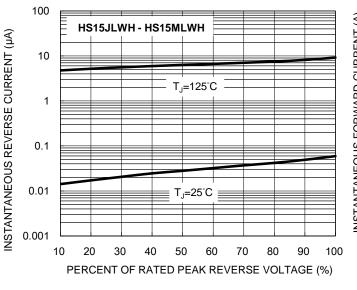
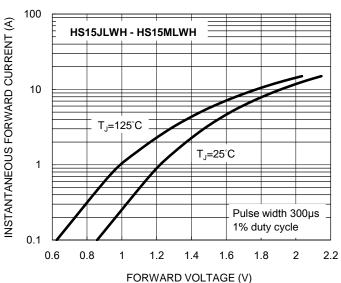
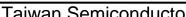


Fig.8 Typical Forward Characteristics

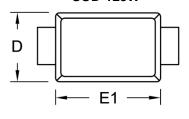


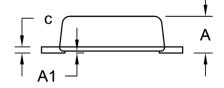


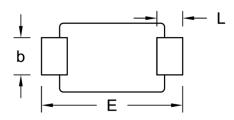


PACKAGE OUTLINE DIMENSIONS

SOD-123W

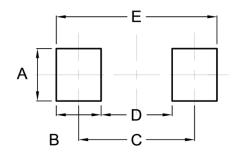






DIM. Uni		(mm) Unit (ind		(inch)
Diwi.	Min.	Max.	Min.	Max.
Α	0.90	1.02	0.035	0.040
A1	0.00	0.10	0.000	0.004
b	0.90	1.05	0.035	0.041
С	0.10	0.22	0.004	0.009
D	1.70	1.90	0.067	0.075
E	3.60	3.80	0.142	0.150
E1	2.60	2.90	0.102	0.114
L	0.50	0.85	0.020	0.033

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.40	0.055
В	1.20	0.047
С	3.10	0.122
D	1.90	0.075
E	4.30	0.169

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code F = Factory Code



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